

Committed to providing innovative solutions

for material surface treatment.

NE-PE13F (H)

(Wafer Dedicated) LOW PRESSURE PLASMA ETCHING SYSTEM





NE-PE13F(H) PROFILE

NE-PE13F(H) is a vacuum plasma system specially designed for processing wafers and silicon wafers for degumming, cleaning and activation. Plasma treatment is the process of removing the photoresist by burning off the organics. Using a processing tool, monatomic plasma is created by exposing oxygen or fluorine gas at low pressure to high-power radio waves, which ionise it. This process is performed under vacuum to create a plasma that turns the photoresist to ash.

It is widely used in scientific research institutions, enterprise R&D units and small batch production proofing, including:

- Plasma cleaning organics
- Plasma surface activation to improve adhesion
- Wafer Cleaning
- Descum for WLP
- Stripping & Etch for WLP
- Wafer Pre-Treatment
- BCB & UBM Adhesion
- Dielectric Patterning
- Via Cleaning for WLP



NE-PE13F(H) FEATURES

♦ Compact, tabletop unit

Weight: 80KG

Size: $640 \text{mm}(W) \times 665 \text{mm}(D) \times 580 \text{ mm}(H)$

♦ Special cavity mechanism and discharge electrode for RIE

The unique cavity structure design and air intake mode greatly improve the processing capacity and efficiency, and ensure uniformity.

♦ Adjustable power settings

The max RF power is 300W which can be adjusted continuously.

♦ Stainless steel cavity

Durable high-quality stainless steel dedicated electrodes with tray.

Size: 240(L)×280(D)×200(H)mm



Shenzhen Naen Tech Co., Ltd

Website: www.cnplasma.com

TEL: (+86) 0173-0267-6848

Email: naentech.plasma@gamil.com

♦ Self-developed power supply

Digital high-frequency plasma generator produces high-density contour particles to ensure outstanding cleaning effect.

♦ MFC high precision control of gas flow

Two gas channels are standard, supports various process gases, such as oxygen, argon, hydrogen, nitrogen, etc.

♦ Pro-environment

Dry processing, low gas emission, no hazardous emissions, no pollution to the air.

♦ 7" Touch screen

The whole process can be directly set and processed through the touch screen, which is intuitive and the process can be monitored in real time. It can support multiple program recipe processing at the same time.

♦ Vacuum pump

Equipped with a high-speed vacuum pump, the ideal vacuum value can be reached within 30 seconds, saving the entire processing time.

♦ Fast treatment time

A cycle only takes two to five minutes, and processing times can be set according to demand, with a maximum processing time of 9,999 seconds.

NE-PE13F (H) SPECIFICATIONS

	STANDARD MODEL	OPTIONAL	
Overall dimensions			
Size	640mm(W)×665mm(D) ×580 mm(H)		
Weight	80KG(Including vacuum pump)		
Plasma generator			
Power	0-300W(Adjusted)		
Frequency	13.56Mhz		
Radiation-resistant	High-speed automatic matching within 0.1s, network		
high-frequency matcher	communication supported		
Vacuum chamber			
Cavity material	316 stainless steel, military grade seal		
Cavity volume	13.5L		
Cavity size	240(L)×280(D)) ×200(H)mm		
Effective processing range	210 (W) *204(D)mm		
Layers	3		
Uniformity of etching	≤±15%		
Discharge electrode			
Electrode	High conductive aluminum alloy special electrode		
Discharge modes	CCP & RIE		

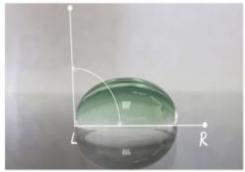


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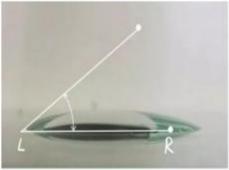
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Gas Control			
Gas flow controller	MFC		
Flow value	0-300sccm		
Gas channel	2 channels(supports various process gases, such as	3 & 4 channels	
	oxygen, argon, hydrogen, nitrogen, etc.)		
Vacuum measurement			
Vacuometer	Pirani high precision resistance vacuum gauge		
Pumping system			
Pumping speed	16 m³/H, oil pump	Dry pump	
Limiting vacuum	1PA		
Control system			
Touch screen	7"		
PLC	Panasonic		
Software	Plasma control system with independent patent: 3 - level		
	permissions, auto/manual modes, recipe param		
	setup/storage/call, alarm history query, IO monitoring.		
Real-time monitoring	Power, vacuum degree, air pressure, gas flow rate,		
	working hours, etc.		
Alarm function	Vacuum anti-misoperation, power anti-misoperation, air		
	pressure alarm, phase sequence alarm		
Condition			
Power Supply	220V		
Type of air pipe	Ф 8mm		
Gas purity	99.999%		
Gas pressure	0.3-0.6Mpa		
Exhaust port	KF25		

TYPICAL PROCESS RESULTS







Contact Angle After Treatment



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ABOUT NAEN TECH

Naen Tech are an international leader in the design, development and manufacture of plasma surface treatment systems & advanced plasma processes.

Our products are installed worldwide and trusted to deliver consistent, reliable results in both leading research institutes and in critical manufacturing steps.

We are experts in plasma technology and surface science. We are trusted partners, valued for our courtesy, professionalism and dedication to delivering the correct solution for our clients.

OUR SERVICES

Contract plasma treatment

We have more than 10,000 customer cases around the world, and we are equipped with technicians who can meet the plasma needs of various industries, and will provide a quick, no-nonsense feasibility solution for the surface treatment needs of different segments!

Surface testing laboratory

With a comprehensive suite of surface analysis equipment, we are able to conduct a wide range of surface property tests, both before and after plasma treatment, in order to provide you a professional report with the whole pictures and videos.

After sales support

The equipment is guaranteed for one year free of charge and provides lifetime technical services.

If the equipment fails (non-human damage), we will arrange after-sales personnel to follow up within 24 hours until the fault is eliminated.

Rental plasma systems

We carry a wide range of our standard equipment in stock and available for short or long term hire. This is particularly useful for in-house proof of concept trials or to satisfy short term contract work.

Method development

We have invested significantly in laboratory facilities to assess, test and investigate all aspects of plasma surface modification on a wide range of materials. Coupled with extensive in-house and real-world knowledge, we can usually deliver a tailored treatment quickly and efficiently to suit your individual product or production needs.



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